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PCB Rev: B

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Designed for: Public Release		Mod. Date: 11/5/2013	
Project Title: UCC28710 High-side Buck Converter			
Number: PMP9087	Rev: B	Sheet Title: 85Vac- 265Vac to 12V/0.2A	
SVN Rev: Not in version control		Assembly Variant: 001	Sheet: 1 of 2
Drawn By: S Yu		File: PMP9087_01.SchDoc	Size: B
Engineer: Enter name of project lead		Contact: http://www.ti.com/support	



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